

PMP21278 REV A Bill of Materials

Designator	Quantity	Value	PartNumber	Manufacturer	Description	PackageReference
IPCBB?	1		SV601348A	Any	Update Description to match PCB's description	N/A
C1, C31	2	100uF	PCR1J101MCL1GS	Nichicon	CAP, Aluminum Polymer, 100 μ F, 63 V, +/- 20%, 0.024 ohm, SMD, 2-Leads, Dia 10.5mm, Pin Spacing 8mm SMD	SMD, 2-Leads, Dia 10.5mm, Pin Spacing 8mm
C2, C3, C4, C5, C32, C33, C34, Cx1, Cx2, Cx3, Cx4, Cx5, Cx6, Cx7	14	4.7uF	GRM32ER71K475KE14L	MuRata	CAP, CERM, 4.7 μ F, 80 V, +/- 10%, X7R, 1210	1210
C6, C7, C8, C9, C10, C11	6	22uF	GRM32ER71E226KE15L	MuRata	CAP, CERM, 22 μ F, 25 V, +/- 10%, X7R, 1210	1210
C12	1	1uF	GRM219R71E105KA88D	MuRata	CAP, CERM, 1 μ F, 25 V, +/- 10%, X7R, 0805	0805
C13, C14, Cx8	3	330uF	16SVP330M	Sanyo	CAP, OS-CON, 330 μ F, 16 V, +/- 20%, 0.016 ohm, 10x10.3 SMD	10x10.3
C15	1	47pF	GRM1885C1H470JA01D	MuRata	CAP, CERM, 47pF, 50V, +/-5%, COG/NPO, 0603	0603L
C16	1	4.7uF	GRM21BR71C475KA73L	MuRata	CAP, CERM, 4.7 μ F, 16 V, +/- 10%, X7R, 0805	0805
C17	1	0.1uF	GRM188R72A104KA35D	MuRata	CAP, CERM, 0.1uF, 100V, +/-10%, X7R, 0603	0603
C18, C19, C25	3	0.22uF	GRM188R71E224KA88D	MuRata	CAP, CERM, 0.22 μ F, 25 V, +/- 10%, X7R, 0603	0603
C20, C30	2	100pF	GRM1885C2A101JA01D	MuRata	CAP, CERM, 100pF, 100V, +/-5%, COG/NPO, 0603	0603L
C21	1	0.15uF	GRM188R71E154KA01D	MuRata	CAP, CERM, 0.15 μ F, 25 V, +/- 10%, X7R, 0603	0603
C22	1	0.033uF	GRM188R71H333KA61D	MuRata	CAP, CERM, 0.033 μ F, 50 V, +/- 10%, X7R, 0603	0603
C24	1	0.33uF	GRM188R71C334KA01D	MuRata	CAP, CERM, 0.33 μ F, 16 V, +/- 10%, X7R, 0603	0603
C27	1	0.022uF	C0603C223K5RACTU	Kemet	CAP, CERM, 0.022uF, 50V, +/-10%, X7R, 0603	0603
C28	1	1200pF	GRM188R71E122KA01D	MuRata	CAP, CERM, 1200 pF, 25 V, +/- 10%, X7R, 0603	0603
C29	1	220pF	GRM1885C1H221JA01D	MuRata	CAP, CERM, 220 pF, 50 V, +/- 5%, COG/NPO, 0603	0603
D1	1	20V	RSX501L-20TE25	Rohm	Diode, Schottky, 20 V, 5 A, SMA	SMA
D2	1	60V	RB050L-60TE25	Rohm	Diode, Schottky, 60 V, 3 A, SMA	SMA
D3	1	60V	PMEG6010CEJ,115	NXP Semiconductor	Diode, Schottky, 60 V, 1 A, SOD-323F	SOD-323F
D4, D5	2	100V	BAS316,115	NXP Semiconductor	Diode, Ultrafast, 100V, 0.25A, SOD-323	SOD-323
H1, H2, H3, H4	4		NY PMS 440 0025 PH	B&F Fastener Supply	Machine Screw, Round, #4-40 x 1/4, Nylon, Philips panhead	Screw
H5, H6, H7, H8	4		1902C	Keystone	Standoff, Hex, 0.5"L #4-40 Nylon	Standoff
J1, J2, J3, J4	4		575-8	Keystone	Standard Banana Jack, Uninsulated, 8.9mm	Keystone575-8
L1	1	2uH	XAL1580-202MEB	Coilcraft	Inductor, Shielded, Composite, 2 μ H, 39.9 A, 0.001909 ohm, SMD	15.2x8x16.2mm
Q1, Q2, Q3, Q4	4	80V	CSD19502Q5B	Texas Instruments	MOSFET, N-CH, 80 V, 100 A, DNK0008A (VSON-CLIP-8)	DNK0008A
Q5, Q6, Q7, Q8	4	30V	CSD17573Q5B	Texas Instruments	MOSFET, N-CH, 30 V, 100 A, DNK0008A (VSON-CLIP-8)	DNK0008A
R1_1, R1_2	2	0.004	KRL6432E-M-R004-F-T1	Susumu Co Ltd	RES, 0.004, 1%, 3 W, 2512 WIDE	2512 WIDE
R2, R3, R4, R5, R12, R17, R24, R25, R26, R27	10	0	RC0603JR-070RL	Yageo America	RES, 0 ohm, 5%, 0.1W, 0603	0603L
R6, R8, R16, R21	4	100	RC0603FR-07100RL	Yageo America	RES, 100 ohm, 1%, 0.1W, 0603	0603L
R7_1, R7_2	2	0.005	FCSL64R005FER	Ohmite	RES, 0.005, 1%, 2 W, 2512 WIDE	2512 WIDE
R9, R11	2	10.0	RC0603FR-0710RL	Yageo America	RES, 10.0 ohm, 1%, 0.1W, 0603	0603L
R10	1	10.0k	RC0603FR-0710KL	Yageo America	RES, 10.0k ohm, 1%, 0.1W, 0603	0603L
R13	1	249k	RC0603FR-07249KL	Yageo America	RES, 249k ohm, 1%, 0.1W, 0603	0603
R14	1	280k	RC0603FR-07280KL	Yageo America	RES, 280k ohm, 1%, 0.1W, 0603	0603L
R15	1	2.00k	CRCW06032K00FKEA	Vishay-Dale	RES, 2.00 k, 1%, 0.1 W, 0603	0603
R18	1	37.4k	CRCW060337K4FKEA	Vishay-Dale	RES, 37.4 k, 1%, 0.1 W, 0603	0603
R19	1	93.1k	RC0603FR-0793K1L	Yageo America	RES, 93.1 k, 1%, 0.1 W, 0603	0603
R20	1	33.2k	CRCW060333K2FKEA	Vishay-Dale	RES, 33.2 k, 1%, 0.1 W, 0603	0603
R22	1	20.0k	RC0603FR-0720KL	Yageo America	RES, 20.0k ohm, 1%, 0.1W, 0603	0603L

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R23	1	6.04k	CRCW06036K04FKEA	Vishay-Dale	RES, 6.04 k, 1%, 0.1 W, 0603	0603
R28, Rx1	2	0.082	RLP73N3AR082FTDF	TE Connectivity	RES, 0.082, 1%, 2 W, AEC-Q200 Grade 0, 2512	2512
R29	1	0	RCL12250000Z0EG	Vishay Draloric	RES, 0, 5%, 2 W, 2512 WIDE	2512 WIDE
S1, S2, S3	3		CJS-1201TA	Copal Electronics	Slide SW, SPDT 0.1A 50VDC	SW, 3.1x2.5x6 mm
TP1, TP3	2	Red	5005	Keystone	Test Point, Compact, Red, TH	Red Compact Testpoint
TP2, TP4	2	Black	5006	Keystone	Test Point, Compact, Black, TH	Black Compact Testpoint
TP5	1	PGOOD	5007	Keystone	Test Point, Compact, White, TH	White Compact Testpoint
TP6, TP7	2	White	5007	Keystone	Test Point, Compact, White, TH	White Compact Testpoint
U1	1		LM5176PWPR	Texas Instruments	55 V Wide VIN Synchronous 4-Switch Buck-Boost Controller, PWP0028C (TSSOP-28)	PWP0028C
C23, C26	0	47pF	GRM1885C1H470JA01D	MuRata	CAP, CERM, 47pF, 50V, +/-5%, C0G/NP0, 0603	0603L
C35, C36, C37, C38, C39	0	4.7uF	GRM32ER71K475KE14L	MuRata	CAP, CERM, 4.7 μF, 80 V, +/- 10%, X7R, 1210	1210
FID1, FID2, FID3	0		N/A	N/A	Fiducial mark. There is nothing to buy or mount.	Fiducial
L2	0	2.2uH	XAL1010-222MEB	Coilcraft	Inductor, Shielded, Composite, 2.2 μH, 32 A, 0.00255 ohm, SMD	Inductor, 11.3x10x10mm

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